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DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63) <input type="checkbox"/> Declaration Submitted with Initial Filing OR <input checked="" type="checkbox"/> Declaration Submitted after Initial Filing (surcharge (37 CFR 1.16 (e)) required)	Attorney Docket Number	
	First Named Inventor	Hammer
	COMPLETE IF KNOWN	
	Application Number	10 / 055,785
	Filing Date	01/09/2002
	Art Unit	2859
	Examiner Name	Stanley Pruchnic, Jr.

As the below named inventor, I hereby declare that:

My residence, mailing address, and citizenship are as stated below next to my name.

I believe I am the original and first inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Conducted Heat Vector Sensor

(Title of the Invention)

the specification of which

☐ is attached hereto

OR

☒ was filed on (MM/DD/YYYY) 01/09/2002 as United States Application Number or PCT International

Application Number 10/055,785 and was amended on (MM/DD/YYYY) (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent, inventor's or plant breeder's rights certificate(s), or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent, inventor's or plant breeder's rights certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Not Claimed	Certified Copy Attached?	
				YES	NO
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>
			<input type="checkbox"/>	<input type="checkbox"/>	<input type="checkbox"/>

☐ Additional foreign application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto:

[Page 1 of 2]

DECLARATION — Utility or Design Patent Application

Direct all correspondence to: ☒ Customer Number or Bar Code Label ☐ OR ☒ Correspondence address below

Name Lawrence W. Langley

Address 2733 Big Falls Road

City Blacksburg

State VA

ZIP 24060

Country USA

Telephone (540) 961-2001

Fax 953-3010

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

NAME OF SOLE OR FIRST INVENTOR: ☐ A petition has been filed for this unsigned inventor

Given Name
(first and middle [if any]) Robert

Family Name
or Surname Hammer

Inventor's
Signature

Robert Hammer

Date 4/29/03

Residence: City Floyd

State VA

Country USA

Citizenship USA

Mailing Address 664 Beaver Creek Road, NW

City Floyd

State VA

ZIP 24091

Country USA

NAME OF SECOND INVENTOR: ☐ A petition has been filed for this unsigned inventor

Given Name
(first and middle [if any]) Lawrence W.

Family Name
or Surname Langley

Inventor's
Signature

Lawrence W. Langley

Date 4/29/03

Residence: City Blacksburg

State VA

Country USA

Citizenship USA

Mailing Address 2733 Big Falls Road

City Blacksburg

State VA

ZIP 24060

Country USA

☐ Additional inventors are being named on the ____ supplemental Additional Inventor(s) sheet(s) PTO/SB/02A attached hereto.



A DOCPHOENIX

APPL PARTS

IMIS
Internal Misc. Paper
LET
Misc. Incoming Letter

371P
PCT Papers in a 371 Application
50 03 A... 2
Amendment Including Elections

ABST
Abstract

ADS
Application Data Sheet

AF/D
Affidavit or Exhibit Received

APPENDIX
Appendix

ARTIFACT
Artifact

BIB
Bib Data Sheet

CLM
Claim

COMPUTER
Computer Program Listing

CRFL
All CRF Papers for Backfile

DIST
Terminal Disclaimer Filed

DRW
Drawings

FOR
Foreign Reference

FRPR
Foreign Priority Papers

IDS
IDS Including 1449

NPL
Non-Patent Literature

OATH
Oath or Declaration

PET.
Petition

RETMAIL
Mail Returned by USPS

SEQLIST
Sequence Listing

SPEC
Specification

SPEC NO
Specification Not in English

TRNA
Transmittal New Application

CTNF
Count Non-Final

CTRS
Count Restriction

EXIN
Examiner Interview

M903
DO/EO Acceptance

M905
DO/EO Missing Requirement

NFDR
Formal Drawing Required

NOA
Notice of Allowance

PETDEC
Petition Decision

OUTGOING

CTMS
Misc. Office Action

1449
Signed 1449

892
892

ABN
Abandonment

APDEC
Board of Appeals Decision

APEA
Examiner Answer

CTAV
Count Advisory Action

CTEQ
Count Ex parte Quayle

CTFR
Count Final Rejection

INCOMING

AP.B
Appeal Brief

C.AD
Change of Address

N/AP
Notice of Appeal

PA..
Change in Power of Attorney

REM
Applicant Remarks in Amendment

XT/
Extension of Time filed separate

Internal
SRNT
Examiner Search Notes
CLMPTO
PTO Prepared Complete Claim Set

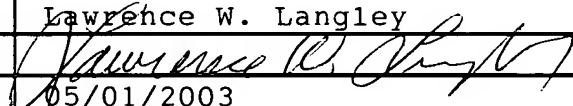
ECBOX
Evidence Copy Box Identification
WCLM
Claim Worksheet
WFEE
Fee Worksheet

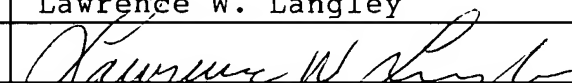
File Wrapper

FWCLM
File Wrapper Claim
IIFW
File Wrapper Issue Information
SRFW
File Wrapper Search Info

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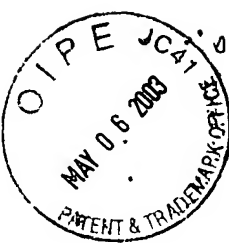
TRANSMITTAL FORM (to be used for all correspondence after initial filing)	Application Number	10/055,785	
	Filing Date	01/09/2002	
	First Named Inventor	Hammer	
	Art Unit	2859	
	Examiner Name	Stanley J. Pruchnic, Jr.	
Total Number of Pages in This Submission	1	Attorney Docket Number	

ENCLOSURES (Check all that apply)		
<input checked="" type="checkbox"/> Fee Transmittal Form	<input type="checkbox"/> Drawing(s)	<input type="checkbox"/> After Allowance communication to Group
<input checked="" type="checkbox"/> Fee Attached	<input type="checkbox"/> Licensing-related Papers	<input type="checkbox"/> Appeal Communication to Board of Appeals and Interferences
<input type="checkbox"/> Amendment/Reply	<input type="checkbox"/> Petition	<input type="checkbox"/> Appeal Communication to Group (Appeal Notice, Brief, Reply Brief)
<input type="checkbox"/> After Final	<input type="checkbox"/> Petition to Convert to a Provisional Application	<input type="checkbox"/> Proprietary Information
<input type="checkbox"/> Affidavits/declaration(s)	<input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address	<input type="checkbox"/> Status Letter
<input type="checkbox"/> Extension of Time Request	<input type="checkbox"/> Terminal Disclaimer	<input type="checkbox"/> Other Enclosure(s) (please identify below):
<input type="checkbox"/> Express Abandonment Request	<input type="checkbox"/> Request for Refund	
<input type="checkbox"/> Information Disclosure Statement	<input type="checkbox"/> CD, Number of CD(s) _____	
<input type="checkbox"/> Certified Copy of Priority Document(s)	Remarks	
<input checked="" type="checkbox"/> Response to Missing Parts/ Incomplete Application		
<input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53		
SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT		
Firm or Individual name	Lawrence W. Langley	
Signature		
Date	05/01/2003	

CERTIFICATE OF TRANSMISSION/MAILING			
I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below.			
Typed or printed name	Lawrence W. Langley		
Signature		Date	05/01/2003

This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

If you need assistance in completing the form, call 1-800-PTO-9199 and select option 2.



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H(540) 633-2733 W(540) 961-2001

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Jal completed exam 7/15/03
May 1, 2003
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IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF

Robert Hammer et al

Group Art Unit: 2859

Serial No. 10/055,785

Examiner: Stanley J. Pruchnic, Jr.

Filed: 01/09/2002

For: Conducted Heat Vector Sensor

The Honorable Commissioner of
Patents and Trademarks
Washington, D.C. 20231

RECEIVED
MAY - 8 2003
TECHNOLOGY CENTER 2800

Response to Office Action of 3/10/03

Enclosed is a new Declaration by Inventors with the \$65.00 surcharge for late filing required by 37 CFR 1.16(e)

Please replace page 1 of the disclosure with the attached page 1 and re-number the succeeding pages of the disclosure as 2-14. Also, delete page numbers on the drawings and the claims

Make the following changes to the claims.

Claim 9, second line, delete second occurrence of the word "a".

Cancel Claim 4 and 5.

Add the following claims 12-20:

12. The sensor of Claim 2 in which said plug is slotted on the side.

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OK to exam
5/20/03 spec
page with 5/20/03
Spec of page #10
-520 7/15/03

Cont



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APPL PARTS

IMIS
Internal Misc. Paper
LET
Misc. Incoming Letter

371P
 PCT Papers in a 371 Application
 A...
 Amendment Including Elections
 ABST
 Abstract
 ADS
 Application Data Sheet
 AF/D
 Affidavit or Exhibit Received
 APPENDIX
 Appendix
 ARTIFACT
 Artifact
 BIB
 Bib Data Sheet
 CLM
 Claim
 COMPUTER
 Computer Program Listing
 CRFL
 All CRF Papers for Backfile
 DIST
 Terminal Disclaimer Filed
 DRW
 Drawings
 FOR
 Foreign Reference
 FRPR
 Foreign Priority Papers
 IDS
 IDS Including 1449

NPL
 Non-Patent Literature
 OATH
 Oath or Declaration
 PET.
 Petition
 RETMAIL
 Mail Returned by USPS
 SEQLIST
 Sequence Listing
 SPEC
 Specification
 SPEC NO
 Specification Not in English
 TRNA
 Transmittal New Application

CTNF
 Count Non-Final
 CTRS
 Count Restriction
 EXIN
 Examiner Interview
 M903
 DO/EO Acceptance
 M905
 DO/EO Missing Requirement
 NFDR
 Formal Drawing Required
 NOA
 Notice of Allowance
 PETDEC
 Petition Decision

OUTGOING

CTMS
Misc. Office Action

1449
 Signed 1449
 892
 892
 ABN
 Abandonment
 APDEC
 Board of Appeals Decision
 APEA
 Examiner Answer
 CTAV
 Count Advisory Action
 CTEQ
 Count Ex parte Quayle
 CTFR
 Count Final Rejection

INCOMING

AP.B
 Appeal Brief
 C.AD
 Change of Address
 N/AP
 Notice of Appeal
 PA...
 Change in Power of Attorney
 REM
 Applicant Remarks in Amendment
 XT/
 Extension of Time filed separate

Internal

SRNT
 Examiner Search Notes
 CLMPTO
 PTO Prepared Complete Claim Set

ECBOX
 Evidence Copy Box Identification
 WCLM
 Claim Worksheet
 WFEE
 Fee Worksheet

File Wrapper

FWCLM
 File Wrapper Claim
 IIFW
 File Wrapper Issue Information
 SRFW
 File Wrapper Search Info

13. The sensor of Claim 2 in which said plug is slotted on the end.

14. A sensor for measuring temperature differences between a first and a second point within a solid body comprising:

a first and a second thin film thermocouple,

means for imbedding said first thin film thermocouple in said solid body at said first point,

means for imbedding said second thin film thermocouple in said solid body at said second point,

and

means for measuring the difference in output potentials of said thin film thermocouples.

Q' 15. The sensor of claim 14 in which said means for imbedding said thermocouples consists of a
Pnd plug closely fitting into a hole in said solid body and said thermocouples are deposited on said plug.

16. The sensor of claim 14 in which said means for imbedding said thermocouples consists of a thin substrate, and said thermocouples are deposited on said substrate.

17. The sensor of claim 16 further comprising a thin cover for said substrate.

18. The sensor of claim 15 in which the thermal properties of said plug match those of said solid body.

19. The sensor of claim 16 in which the thermal properties of said substrate match those of said solid body.

20. The sensor of claim 17 in which the thermal properties of said substrate and said cover match those of said solid body.

SA Claims 6 (two occurrences), and Claims 7, 8 and 10, change "object" to "body".

SP Claim 9, last line, add "for measuring its potential"

Discussion

The replacement Oath or Declaration contains a mailing address for both inventors.

A replacement Page 1 without the abstract is enclosed, and the pages of the application have been re-numbered according to Examiner's suggestion.

The second occurrence of the word "a" in Claim 9, second line has been deleted.

Examiner states, "- - - Sallée discloses the materials of the detector head matching the thermal properties of the solid object." Applicants respectfully request that examiner locate this text for them in the referenced patent.

Examiner rejected applicants' Claims 4 and 5 as being indefinite under 35 U.S.C. 112. These claims have been replaced by new Claims 12 and 13 which depend on Claim 2 and properly refer to the antecedents in this claim.

Applicants have changed terms in Claims 6,7,8 and 10 from "solid object" to "solid body", which conforms better to usage in the disclosure.

Examiner has rejected Claims 9, 10 and 11 Under 35 U.S.C. 112, second paragraph, as being incomplete for omitting essential steps. Only one step is omitted, that of measuring the thermopile potential. Claim 9 has been modified to correct this omission. The omissions in Claims 10 and 11 are corrected by their dependency on Claim 9.

Examiner rejected applicants' Claims 1 and 3-10 under 35 U.S.C. 103(a) as being unpatentable over Sallée et al, (US patent 4,817,436) in view of Nanigian (US patent 3,372,587). Examiner also rejected applicants' Claims 2 and 11 under 35 U.S.C. 103(a) as being unpatentable over Sallée et al in view of Nanigian and further in view of Medtherm. Applicants respectfully traverse examiner's rejections. The teaching of the Sallée et al patent combined with the teaching of Nanigian will not yield a heat flux sensor with the unique and novel performance characteristics of applicants' invention.

Sallée discloses a flexible heat flux sensor comprising a thin composite structure of copper, constantan and mylar sheets, etched and bonded together. The patent does not describe how this combination senses heat flux, and does not indicate the direction of heat flow through the device. However, the design is well described in the reference "Measurements on the thermoelectric properties of thin layers of two metals in electrical contact. Application for designing new heat-flow sensors", Meas. Sci. Technol. 3 (1992), Ph. Herin and P. Théry, pp 495-500. A copy of this reference is attached.

The Sallée et al device measures heat flux passing through its thinnest dimension by creating small local temperature gradients normal to the heat flow, i.e. in the plane of the device. The gradients are produced by geometric asymmetries in the heat flow paths around rectangular voids

in the composite. Pairs of copper/Constantan thermocouples on opposite sides of the voids sense these gradients and produce slightly different voltages. When connected in series opposition the net voltage of each pair of thermocouples is proportional to the heat flow. The small net voltages for many pairs of thermocouples are summed by series connection to produce a larger signal indicative of heat flux. Because the basic measuring principle requires that temperature gradients be developed in the plane of the device, it is not well suited to measuring conductive (or convective) heat flux. If a surface of the device were to be placed in contact with a thermally conductive solid, or if the device were to be imbedded in a solid body, the temperature gradients in the plane of the sensor would be reduced or eliminated by conduction through the conductive solid, and the sensitivity of the device to heat flux would be reduced by an indeterminate amount. Sallée et al have added thin layers of mylar 2 and 24, and layers of copper 20 and 26 on the faces of the device to reduce this effect, but it cannot be eliminated.

Applicants' objectives for their invention could not be achieved by utilizing the Sallée et al device or its principles. If this device were directly substituted for the thin film thermopile of applicants' invention, the resulting sensor would be completely insensitive to heat flux along the sensor axis. To cause heat to flow through the device and provide sensitivity to the axial component of heat flux, it would have to be installed at right angles to the axis so that heat would flow through its thinnest dimension. This would present a large area with different thermal properties from those of the solid object whose heat flux is to be measured. Heat would be shunted around the sensor, and the pattern of heat flow in the solid object would be severely perturbed.

By contrast applicants' invention presents an extremely small area in the direct path of heat, an "end-on" view of the thin films. Because the thin films are tightly held between surfaces of a material whose thermal properties closely match those of the solid object, the perturbation of heat flow will be negligible, regardless of its actual direction. There is no way to imbed the Sallée et al device in a solid object to achieve a comparatively negligible distortion of heat flow.

Despite its title, the Nanigian patent does not describe a direct reading heat flow detector. What it does describe is a temperature sensor with provisions to minimize perturbations in heat flow caused by installation of the sensor in a solid object. To measure heat flow with this sensor, one must calculate the first derivative of measured temperature and apply scaling factors that are functions of the physical dimensions and material properties of the solid object. This is what is generally termed an "inverse" problem. The undesirable magnification of noise and error by the required mathematical differentiation process is well known. The means for calculating a heat flux from the signals of this device are not described in the patent.

Substitution of the Sallée et al device for the flat plate of the Nanigian patent would result in a heat flux sensor, but one that would significantly perturb the flow of heat. In column 2, line 67-72 of Nanigian the inventor warns against trapping air bubbles during installation and potting of the sensing element in the wall. "- - - any such would cause errors due to their interference with the normal flow of heat by virtue of their different heat transmission characteristics as compared with the wall." However, the Sallée et al device contains many voids that are required for it to function as a heat flux sensor. These are clearly identified as channels 16 in Figure 2a of the

patent. Thus the two patents teach in opposite directions and cannot reasonably be combined.

One might ask why applicant's invention has not been derived by others from Sallée and Nanigian, given that the former has been available to the public for almost 14 years, the latter for over 25. The answer is that they cannot be combined in any way to achieve the desired characteristics. Only by imbedding a thin film thermopile within the object as taught by applicants, can the following objectives be achieved:

simplicity of construction;
negligible disturbance of heat flow in the object;
measurement accuracy;
durability in service;
wide operating temperature range; and
low cost.

In their invention applicants have used the characteristics of a thin film thermopile to particular advantage. While the metals making up the thermopile may have very different thermal properties from those of the surrounding material, the cross-sections and masses of the metal films are so small that only a negligible perturbation of heat flow results. If the dimensions of the thermopile and the properties of surrounding material are accurately known, heat flux can even be deduced from the sensor signal without a prior calibration.

In a recent joint proposal by Vatel Corporation and Oak Ridge National Laboratory to the Department of Energy entitled Heat Flux Sensors for Materials Processing, the characteristics of applicants' sensor and its advantages were described. Following is a direct quotation from that proposal.

1.1 Nonproprietary Project Summary

In this work, heat flux sensors will be designed and fabricated for data acquisition and process monitoring in metallurgical processes. The sensors will provide information on the heat transfer at solidifying interfaces for those industrial processes in which the processing material evolves from a state of liquid, semisolid, to solid state. By measuring directly the heat fluxes at interfaces with processing materials, the design and monitoring of materials processes will be enhanced. The knowledge of the instants at which the interface gaps appear and grow would provide a new process monitoring tool. In addition, the direct heat flux data measured by the sensor will provide important and accurate data for the design of molds, risers, and gating systems in the aluminum, metalcasting, and steel industries. The robust design of the sensors for high performance and extended life in hostile environments will include selective coating of the sensor components using advanced photonics processing techniques.

1.2 Project Relevance to the research priorities identified in the technology roadmaps

The proposed heat flux sensors will revolutionize solidification processing through (a) the measurement of heat flux at solidifying interfaces, a quantity that is inherently sensitive to

small interfacial changes, creating new opportunities for process monitoring and control, and (b) providing a new tool for determining more accurate heat transfer coefficients without involving cumbersome inverse heat transfer analyses.

The project will address sensors needs of at least three Industries of the Future:

Aluminum industry: The proposed sensors will be applicable to aluminum industry as a new monitoring tool, which is highly desired by the industry: "Limitations in sensors and other measurement capabilities currently restrict aluminum fabricators' knowledge of process specifics, in turn limiting the precision with which they can control processes to optimize productivity, quality, and efficiency." (p. 29). The sensors will also provide very useful information on temperature gradients at mold surfaces (see Exhibit 4-2, p. 30. on Sensors and Measurement - "Inability to measure thermal gradients in the process for temperature control.")

Steel industry; Generic casting: The sensor will enable (a) "Develop the ability to monitor the process to ensure consistent quality." (p. 31, p. 48), (b) "Develop advanced heat transfer and fluid flow models." (p. 48) through more accurate estimates of heat transfer boundary conditions at solidifying interfaces, and (c) "Enhance education on the science and engineering principles involved in the design and operation of casters." (p. 48).

Metalcasting industry: Since it addresses major technological barriers, there is a strong potential for the proposed sensor to revolutionize the metal casting industry. Example of road map areas impacted by the proposed sensors include: (a) Major Technological barriers: Sensors and controls: "current sensors cannot detect subtle changes" (Exhibit 4-2, p. 32); the heat flux sensor is inherently very sensitive to the interfacial changes, such as the appearance of mold-casting interface, (b) R&D Needs in Manufacturing by Time Frame: Sensors and controls: "Develop robust sensors and controls suitable for hostile environments." (High priority, Exhibit 4-3, p. 36), (c) "Available sensors and controls are not robust or sophisticated enough to measure and control all the process parameters." (p. 34), and (d) "The lack of advanced sensors and process controls that can withstand the hostile environments inside and around the melting and holding furnaces is a key barrier to achieving energy efficiency goals." (p. 35).

1.3 Organizational Plan and Specialized Capabilities

The key organizations are Secat, Inc., Vatel, Corp., University of Tennessee, MCT, Inc., FlowScience, Inc., and Oak Ridge National Laboratory. Secat, Inc. will be responsible for general coordination of the project.

The collaboration of UT and ORNL will bring a wealth of experience as well as unique facilities and capabilities to bear on the project.

The University of Tennessee will lead the development of coating systems (materials) and coatings-related analysis and assist in the design of sensor.

RNL will leverage its results from the significant effort already underway in the areas of coating and substrate deposition using IR lamp, numerical simulation of solidification processes, the experience and facilities in casting areas, data acquisition and ensuing post-processing. Infrared Processing Center of ORNL is the only center of its kind involved in developing material processing related to wear and corrosion.

Secat, Inc. is a business conceived and dedicated to facilitating research and development of innovative technology and products for the aluminum industry. The project team will have access to aluminum companies that are part of the consortium lead by Secat, Inc.

Vatell, Corp. provides four different types of heat flux measurement instruments, covering a wide area of industrial applications.

Flow Science, Inc. is one of the leading software vendors in computational fluid dynamics and heat transfer that is widely used in casting community.

MCT, Inc. will provide wealth of information and guidance in metal casting requirements during design of the sensors and also provide an access to casting facilities for testing prototype sensors for their optimum performance. (End of quotation)

This quotation is evidence of a long unsatisfied need in the casting industry for a sensor with the characteristics of applicants' invention. The company Medtherm Incorporated, whose product brochure is referenced in examiner's rejection, has been in the heat flux sensor business for over 25 years. That company's engineers are certainly familiar with the state of the art of sensor design. Even so, they have never disclosed or sold sensors with the features and advantages of applicants' invention.

The references cited by examiner are ample evidence that no one having ordinary skill in the art has ever realized the advantages of imbedding a thin film heat flux sensor in a solid object in the manner taught by applicants. After careful review of these references, applicants have concluded that the claims submitted with the original application are not as broad as they might be. New claims 14 through 20 are submitted herewith. The support for this addition is as follows.

The heat flow measurement described by Nanigian is a Type 2 Method - Temperature Change With Time, as termed by Diller. See p. 307, Advances in Heat Transfer, Vol. 23, Academic Press, Inc. Only a single point temperature measurement is required, but the history of the temperature must be recorded over a time and heat flow is then calculated by an inverse method. The Nanigian, Paine and Mele references describe various ways to improve the accuracy of such measurements, but do not contemplate direct sensing of heat flux. By contrast, applicants' invention is a Type 1 Method - Spatial Temperature Difference, also in Diller's terms. It is more commonly known as a direct reading method for measuring heat flux - the signals of the sensor are directly proportional to heat flux.

The Geraschenko, Hevey, Hines, Leins, Malang, Medtherm and Sallée references all refer to direct reading heat flux sensors, but none contemplates the imbedding of a thin film thermopile in a solid body in such a manner as to minimize the distortion of heat flow caused by the sensor. The Sallée and Medtherm sensors measure heat flux along one axis by developing a thermal gradient normal to that axis. This technique cannot be used for conductive heat transfer because the thermal gradient is "shorted out" by contact with the thermally conductive body. The remaining references utilize one or another form of thermal resistance placed in the path of heat flow to produce a thermal gradient aligned with the heat flow. None of these methods can be